

Product/Process Change Notice - PCN 2252A -

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This notice is to inform you of a change that will be made to certain ADI products (see Appendix A) that you may have purchased in the last 2 years. **Any inquiries or requests with this PCN (additional data or samples) must be sent to ADI within 30 days of publication date.** ADI contact information is listed below.

PCN Title:	Expanding waferfab source to ADI's Beaverton/Oregon foundry (ADBN) for MAX14828/MAX14829 devices (RV07B-1A/RV07B-3A)
Publication Date:	24-Feb-2023
Effectivity Date:	29-May-2023 (the earliest date that a customer could expect to receive changed material)
Revision Description:	

Description Of Change:

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For MAX14828/MAX14829 devices

Current waferfab source TowerJazz/San Antonio/Texas (TSSA)

Reason For Change:

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Adding ADBN to expand wafer capacity to ensure supply continuity.

ADBN fab site has been qualified and producing products using S18 process technology since 2013.

ADBN S18 process successfully passed AEC-Q100 qualification, see report attached.

There are no changes to Form/Fit/Function of the devices.

Impact of the change (positive or negative) on fit, form, function & reliability:**Product Identification (this section will describe how to identify the changed material):****Summary of Supporting Information:****Supporting Documents:****ADI Contact Information:**

For questions on this PCN, please send an email to the regional contacts below or contact your local ADI sales representatives.

Americas:	Europe:	Japan:	Korea:	Rest of Asia:
PCN_Americas@analog.com	PCN_Europe@analog.com	PCN_Japan@analog.com	PCN_Korea@analog.com	PCN_ROA@analog.com

Appendix A - Impacted items, see csv PN listing in PCN Zip file